# MSKSEMI 美森科







TSS



MOV



GDT



PIFF

AOD413A-MS

Product specification





# **FEATURES**

- -40V, -12A, RDS(ON) =34mΩ@VGS = -10V
- Improved dv/dt capability
- Fast switching
- 100% PB free and Green Device Available

# **Applications**

- Motor Drive
- Power Tools
- LED Lighting

BVDSS	RDSON	ID
-40V	34mΩ	-12A

#### **Reference News**

PACKAGE OUTLINE	Pin Configuration	Marking
TO-252	Go	MSKSEMI AOD413A MS XXX

# Absolute Maximum Ratings Tc=25℃ unless otherwise noted

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	-40	V
Vgs	Gate-Source Voltage	±20	V
<b>L</b>	Drain Current - Continuous (Tc=25°C)	-12	А
lo	Drain Current - Continuous (Tc=100°C)	-10	Α
Ірм	Drain Current - Pulsed <sup>1</sup>	-36	Α
D-	Power Dissipation (Tc=25°C)	50	W
PD	Power Dissipation - Derate above 25°C	0.28	W/°C
Тѕтс	Storage Temperature Range	-50 to 150	°C
TJ	Operating Junction Temperature Range	-50 to 150	°C

#### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
Reja	Thermal Resistance Junction to ambient		62	°C/W
Reuc	Thermal Resistance Junction to Case		3.6	°C/W



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V <sub>G</sub> s=0V , I <sub>D</sub> =-250uA	-40			V
△BVDSS/△TJ	BVDSS Temperature Coefficient	Reference to 25°C , ID=-1mA		-0.02		V/°C
Ipss	Drain-Source Leakage Current	V <sub>DS</sub> =-40V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			-1	uA
IDSS	Diain-30dice Leakage Current	V <sub>DS</sub> =-32V , V <sub>GS</sub> =0V , T <sub>J</sub> =125°C			-10	uA
Igss	Gate-Source Leakage Current	Vgs=±20V , Vps=0V			±100	nA

#### **On Characteristics**

Dagger	Static Drain-Source On-Resistance	Vgs=-10V , ID=-10A		34	44	mΩ
RDS(ON)	Static Drain-Source On-Resistance	Vgs=-4.5V , Ip=-5A		50	60	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	Vgs=Vps , Ip=-250uA	-1.0	-1.6	-2.5	V
				4.18		mV/°C
gfs	Forward Transconductance	V <sub>DS</sub> =-10V , I <sub>D</sub> =-5A		7		s

#### **Dynamic and switching Characteristics**

Qg	Total Gate Charge <sup>3,4</sup>		 7.6	
Qgs	Gate-Source Charge <sup>3, 4</sup>	V <sub>DS</sub> =-20V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-5A	 2.3	 nC
Qgd	Gate-Drain Charge <sup>3, 4</sup>		 3.1	
Td(on)	Turn-On Delay Time <sup>3,4</sup>		 12	
Tr	Rise Time <sup>3 , 4</sup>	VDD=-20V , VGS=-10V ,	 13.2	 
T <sub>d(off)</sub>	Turn-Off Delay Time <sup>3, 4</sup>	Rg=6Ω lp=-1A	 46.8	 ns
Tf	Fall Time <sup>3 , 4</sup>		 20.4	
Ciss	Input Capacitance		 1076	
Coss	Output Capacitance	V <sub>DS</sub> =-25V , V <sub>GS</sub> =0V , F=1MHz	 83	 pF
Crss	Reverse Transfer Capacitance		 64	
Rg	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz	 16	 Ω

#### **Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			-12	Α
Ism	Pulsed Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-24	Α
VsD	Diode Forward Voltage	Vgs=0V , Is=-1A , T <sub>J</sub> =25°C			-1.2	V

#### Note:

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2.  $V_{DD}$ =-25V, $V_{GS}$ =-10V,L=0.1mH, $I_{AS}$ =-28.6A., $R_{G}$ =25 $\Omega$ ,Starting  $T_{J}$ =25 $^{\circ}$ C
- 3. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- 4. Essentially independent of operating temperature



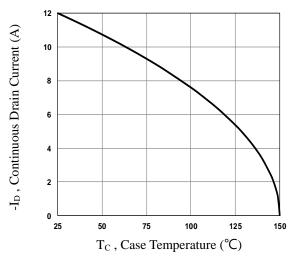


Fig.1 Continuous Drain Current vs. Tc

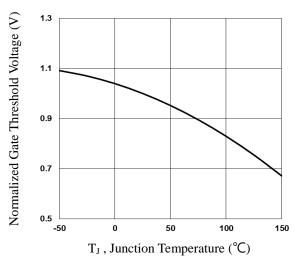


Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>

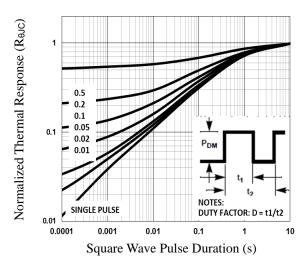


Fig.5 Normalized Transient Impedance

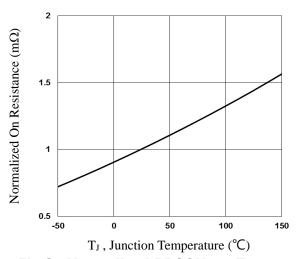


Fig.2 Normalized RDSON vs. T<sub>J</sub>

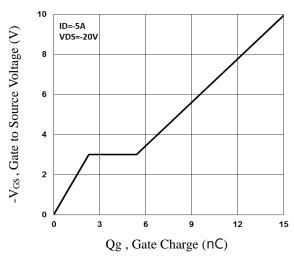


Fig.4 Gate Charge Waveform

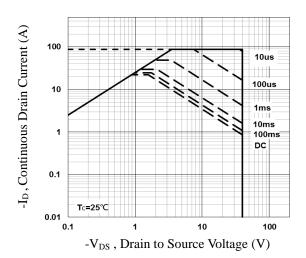


Fig.6 Maximum Safe Operation Area



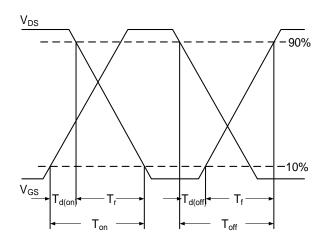
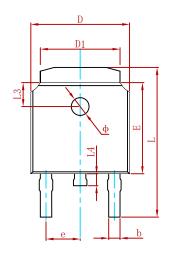
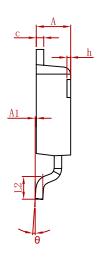


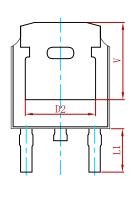
Fig.7 Switching Time Waveform



## PACKAGE MECHANICAL DATA

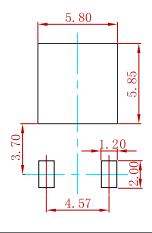






Cumbal	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830	REF.	0.190	REF.
Е	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900	REF.	0.114	REF.
L2	1.400	1.700	0.055	0.067
L3	1.600	REF.	0.063	REF.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250	REF.	0.207 REF.	

# Suggested Pad Layout



#### Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

# **REELSPECIFICATION**

P/N	PKG	QTY
AOD413A-MS	TO-252	2500



#### **Attention**

- Any and all MSKSEMI Semiconductor products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your MSKSEMI Semiconductor representative nearest you before using any MSKSEMI Semiconductor products described or contained herein in such applications.
- MSKSEMI Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all MSKSEMI Semiconductor products described or contained herein.
- Specifications of any and all MSKSEMI Semiconductor products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer'sproducts or equipment.
- MSKSEMI Semiconductor. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with someprobability. It is possiblethat these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents—or events cannot occur. Such measures include but are not limited to protective circuits anderror prevention circuitsfor safedesign, redundant design, and structural design.
- In the event that any or all MSKSEMI Semiconductor products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from theauthorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of MSKSEMI Semiconductor.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. MSKSEMI Semiconductor believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. Whendesigning equipment, refer to the "Delivery Specification" for the MSKSEMI Semiconductor productthat you intend to use.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by MSKSEMI manufacturer:

Other Similar products are found below:

IRFD120 JANTX2N5237 BUK455-60A/B MIC4420CM-TR VN1206L NDP4060 SI4482DY IPS70R2K0CEAKMA1 SQD23N06-31L-GE3
TK16J60W,S1VQ(O 2SK2614(TE16L1,Q) DMN1017UCP3-7 DMN1053UCP4-7 SQJ469EP-T1-GE3 NTE2384 DMC2700UDMQ-7
DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP NTMC083NP10M5L NVMFS2D3P04M8LT1G BXP7N65D
BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR
DMNH15H110SK3-13 SLF10N65ABV2 BSO203SP BSO211P